

IMPACT

TE Internal #: 2057402-1 High Speed Backplane Connectors, Board-to-Board, 60 Position, Mating Alignment, Polarization Mating Alignment Type, 6 Row, 10 Column, IMPACT

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Connectors > PCB Connectors > Backplane Connectors > High Speed Connectors



Connector System: Board-to-Board

Number of Positions: 60

Row-to-Row Spacing: 1.35 mm [.053 in]

Mating Alignment: With

Mating Alignment Type: Polarization

Features

Product Type Features

Signal Arrangement

Connector System

PCB Connector Assembly Type

Differential

Board-to-Board

PCB Mount Receptacle

Shroud Style	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Ground Positions	20
Number of Pairs	20
Stackable	No
Number of Signal Positions	40
Number of Positions	60
Number of Rows	6
Number of Columns	10
PCB Mount Orientation	Right Angle
Guide Location	Unguided
Electrical Characteristics	
Impedance	100 Ω

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Operating Voltage	30 VAC
Signal Characteristics	
Number of Differential Pairs per Column	2
Data Rate	20 – 25 Gb/s
Contact Features	
Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	1.27 μm[50 μin]
Contact Type	Socket
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.75 A

Termination Features

Termination Post & Tail Length	1.2 mm[.047 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Mating Retention	Without
Guide Hardware	Without
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	0
End Wall Location	None
Housing Material	LCP - GF (Liquid Crystal Polymer)

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Housing Color	Black
Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Length	19 mm[.748 in]
Connector Height	10.9 mm[.429 in]
Connector Width	20.1 mm[.791 in]
PCB Thickness (Recommended)	1.6 mm
PCB Hole Diameter	.46 mm[.018 in]
Row-to-Row Spacing	1.35 mm[.053 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL File Number	E28476
UL Rating	Recognized
CSA Certified	Yes

UL Flammability Rating

UL 94V-0

Packaging Features

Packaging Method

Box & Tube, Package

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

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Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

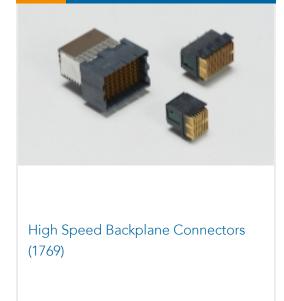
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



TE Part # 2057430-1 IMP100S,H,V2P10C,UG,OEW39,4.5

Also in the Series IMPACT



Customers Also Bought



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TE Part #6368035-3 2X6 OFFSET STK MJ,SHLD,G/YLED

Documents

Product Drawings IMP100S,R,RA2P10C,UG,46

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_2057402-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2057402-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2057402-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications
Application Specification

English

Product Environmental Compliance Product Compliance

English

Product Compliance

English

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Agency Approvals Agency Approval Document

English